

ESP32-S3-MINI-1

ESP32-S3-MINI-1U

User Manual

Small-sized module supporting 2.4 GHz Wi-Fi (802.11 b/g/n) and Bluetooth® 5 (LE)
Built around ESP32-S3 series of SoCs, Xtensa® dual-core 32-bit LX7 microprocessor
8 MB flash
39 GPIOs, rich set of peripherals
On-board PCB antenna or external antenna connector



ESP32-S3-MINI-1



ESP32-S3-MINI-1U



Pre-release v0.6
Espressif Systems
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1 Module Overview

1.1 Features

CPU and On-Chip Memory

- ESP32-S3FN8 embedded, Xtensa® dual-core 32-bit LX7 microprocessor, up to 240 MHz
- 384 KB ROM
- 512 KB SRAM
- 16 KB SRAM in RTC
- 8 MB SPI flash

Wi-Fi

- 802.11 b/g/n
- Bit rate: 802.11n up to 150 Mbps
- A-MPDU and A-MSDU aggregation
- 0.4 μ s guard interval support
- Center frequency range of operating channel: 2412 ~ 2462 MHz

Bluetooth

- Bluetooth LE: Bluetooth 5, Bluetooth mesh
- Speed: 125 Kbps, 500 Kbps, 1 Mbps, 2 Mbps
- Advertising extensions

- Multiple advertisement sets
- Channel selection algorithm #2

Peripherals

- GPIO, SPI, LCD interface, Camera interface, UART, I2C, I2S, remote control, pulse counter, LED PWM, USB 1.1 OTG, USB Serial/JTAG controller, MCPWM, SDIO host, GDMA, TWAI® controller (compatible with ISO 11898-1, i.e. CAN Specification 2.0), ADC, touch sensor, temperature sensor, timers and watchdogs

Integrated Components on Module

- 40 MHz crystal oscillator

Antenna Options

- On-board PCB antenna (ESP32-S3-MINI-1)
- External antenna via a connector (ESP32-S3-MINI-1U)

Operating Conditions

- Operating voltage/Power supply: 3.0 ~ 3.6 V
- Operating ambient temperature: -40 ~ 85 °C

1.2 Description

ESP32-S3-MINI-1 and ESP32-S3-MINI-1U are two powerful, generic Wi-Fi + Bluetooth LE MCU modules that feature a rich set of peripherals, yet an optimized size. They are an ideal choice for a wide variety of application scenarios related to Internet of Things (IoT), such as embedded systems, smart home, wearable electronics, etc.

ESP32-S3-MINI-1 comes with a PCB antenna. ESP32-S3-MINI-1U comes with an external antenna connector. The ordering information of the module is shown in Table 1.

The information in this datasheet is applicable to both modules.

Table 1: Ordering Information

Module	ESP32-S3-MINI-1	ESP32-S3-MINI-1U
Variants	ESP32-S3-MINI-1-N8	ESP32-S3-MINI-1U-N8
Chip Embedded	ESP32-S3FN8	
Flash	8 MB (Quad SPI)	
PSRAM	0	
Dimensions	15.4 × 20.5 × 2.4	15.4 × 15.4 × 2.4

At the core of the modules is an ESP32-S3FN8, an Xtensa® 32-bit LX7 CPU that operates at up to 240 MHz. You can power off the CPU and make use of the low-power co-processor to constantly monitor the peripherals for changes or crossing of thresholds.

ESP32-S3FN8 integrates a rich set of peripherals including SPI, LCD, Camera interface, UART, I2C, I2S, remote control, pulse counter, LED PWM, USB Serial/Jtag, MCPWM, SDIO host, GDMA, TWAI® controller (compatible with ISO 11898-1, i.e. CAN Specification 2.0), ADC, touch sensor, temperature sensor, timers and watchdogs, as well as up to 45 GPIOs. It also includes a full-speed USB 1.1 On-The-Go (OTG) interface to enable USB communication.

Note:

* For more information on ESP32-S3FN8, please refer to [ESP32-S3 Series Datasheet](#).

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2 Pin Definitions

2.1 Pin Layout

The pin diagram below shows the approximate location of pins on the module. The pin diagram is applicable for ESP32-S3-MINI-1 and ESP32-S3-MINI-1U, but the latter has no keepout zone.

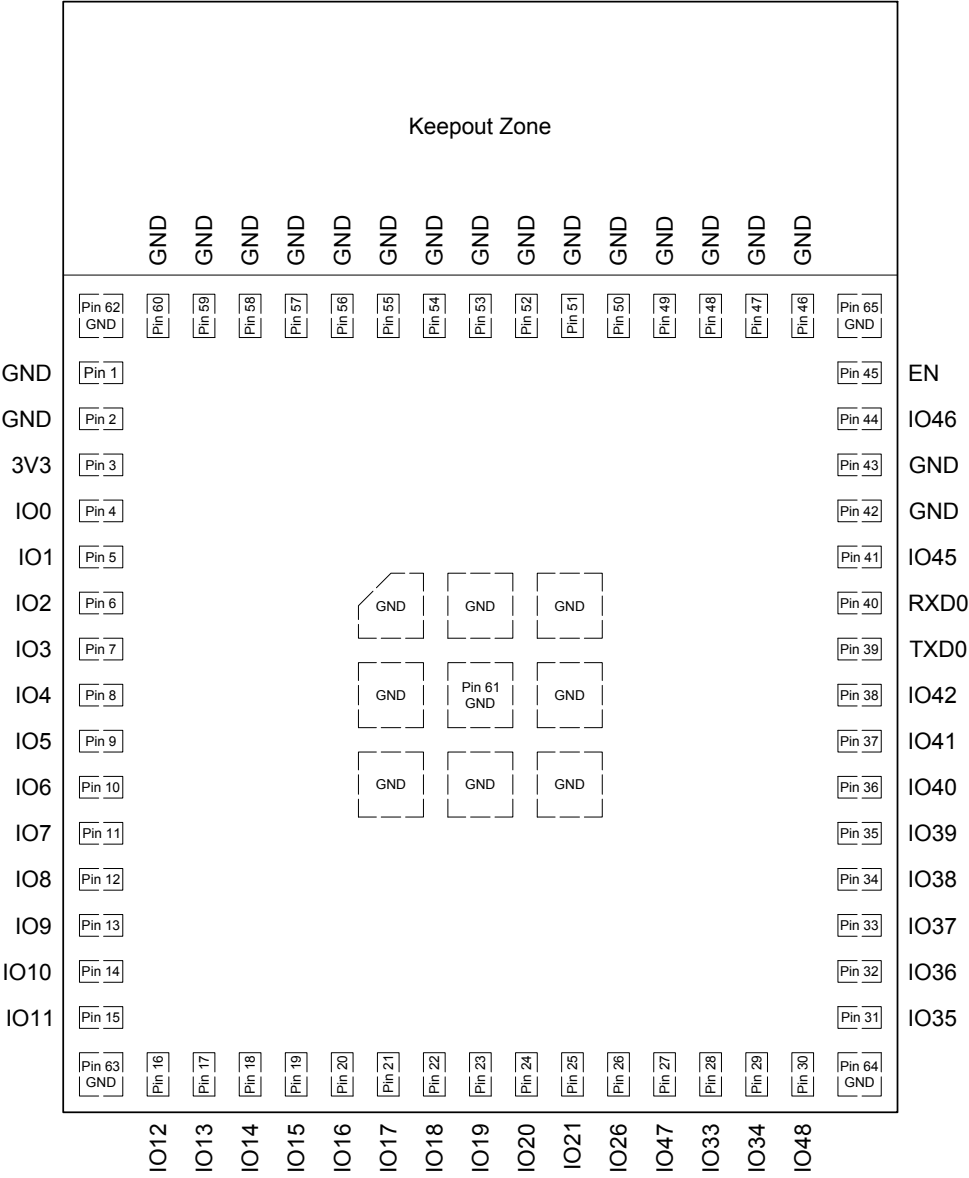


Figure 1: Pin Layout (Top View)

2.2 Pin Description

The module has 65 pins. See pin definitions in Table 2.

For explanations of pin names and function names, as well as configurations of peripheral pins, please refer to [ESP32-S3 Series Datasheet](#).

Table 2: Pin Definitions

Name	No.	Type ^a	Function
GND	1, 2, 42, 43, 46-65	P	GND
3V3	3	P	Power supply
IO0	4	I/O/T	RTC_GPIO0, GPIO0
IO1	5	I/O/T	RTC_GPIO1, GPIO1 , TOUCH1, ADC1_CH0
IO2	6	I/O/T	RTC_GPIO2, GPIO2 , TOUCH2, ADC1_CH1
IO3	7	I/O/T	RTC_GPIO3, GPIO3 , TOUCH3, ADC1_CH2
IO4	8	I/O/T	RTC_GPIO4, GPIO4 , TOUCH4, ADC1_CH3
IO5	9	I/O/T	RTC_GPIO5, GPIO5 , TOUCH5, ADC1_CH4
IO6	10	I/O/T	RTC_GPIO6, GPIO6 , TOUCH6, ADC1_CH5
IO7	11	I/O/T	RTC_GPIO7, GPIO7 , TOUCH7, ADC1_CH6
IO8	12	I/O/T	RTC_GPIO8, GPIO8 , TOUCH8, ADC1_CH7, SUBSPICS1
IO9	13	I/O/T	RTC_GPIO9, GPIO9 , TOUCH9, ADC1_CH8, FSPIHD, SUBSPIHD
IO10	14	I/O/T	RTC_GPIO10, GPIO10 , TOUCH10, ADC1_CH9, FSPICS0, FSPIIO4, SUBSPICS0
IO11	15	I/O/T	RTC_GPIO11, GPIO11 , TOUCH11, ADC2_CH0, FSPID, FSPIIO5, SUBSPID
IO12	16	I/O/T	RTC_GPIO12, GPIO12 , TOUCH12, ADC2_CH1, FSPICLK, FSPIIO6, SUBSPICLK
IO13	17	I/O/T	RTC_GPIO13, GPIO13 , TOUCH13, ADC2_CH2, FSPIQ, FSPIIO7, SUBSPIQ
IO14	18	I/O/T	RTC_GPIO14, GPIO14 , TOUCH14, ADC2_CH3, FSPIWP, FSPIDQS, SUBSPIWP
IO15	19	I/O/T	RTC_GPIO15, GPIO15 , U0RTS, ADC2_CH4, XTAL_32K_P
IO16	20	I/O/T	RTC_GPIO16, GPIO16 , U0CTS, ADC2_CH5, XTAL_32K_N
IO17	21	I/O/T	RTC_GPIO17, GPIO17 , U1TXD, ADC2_CH6
IO18	22	I/O/T	RTC_GPIO18, GPIO18 , U1RXD, ADC2_CH7, CLK_OUT3
IO19	23	I/O/T	RTC_GPIO19, GPIO19 , U1RTS, ADC2_CH8, CLK_OUT2, USB_D-
IO20	24	I/O/T	RTC_GPIO20, GPIO20 , U1CTS, ADC2_CH9, CLK_OUT1, USB_D+
IO21	25	I/O/T	RTC_GPIO21, GPIO21
IO26	26	I/O/T	SPICS1, GPIO26
IO47	27	I/O/T	SPICLK_P_DIFF, GPIO47 , SUBSPICLK_P_DIFF
IO33	28	I/O/T	SPIIO4, GPIO33 , FSPIHD, SUBSPIHD
IO34	29	I/O/T	SPIIO5, GPIO34 , FSPICS0, SUBSPICS0
IO48	30	I/O/T	SPICLK_N_DIFF, GPIO48 , SUBSPICLK_N_DIFF
IO35	31	I/O/T	SPIIO6, GPIO35 , FSPID, SUBSPID
IO36	32	I/O/T	SPIIO7, GPIO36 , FSPICLK, SUBSPICLK
IO37	33	I/O/T	SPIDQS, GPIO37 , FSPIQ, SUBSPIQ
IO38	34	I/O/T	GPIO38 , FSPIWP, SUBSPIWP
IO39	35	I/O/T	MTCK , GPIO39, CLK_OUT3, SUBSPICS1
IO40	36	I/O/T	MTDO , GPIO40, CLK_OUT2
IO41	37	I/O/T	MTDI , GPIO41, CLK_OUT1

Cont'd on next page

Table 2 – cont'd from previous page

Name	No.	Type ^a	Function
IO42	38	I/O/T	MTMS , GPIO42
TXD0	39	I/O/T	U0TXD , GPIO43, CLK_OUT1
RXD0	40	I/O/T	U0RXD , GPIO44, CLK_OUT2
IO45	41	I/O/T	GPIO45
IO46	44	I/O/T	GPIO46
EN	45	I	High: on, enables the chip. Low: off, the chip powers off. Note: Do not leave the EN pin floating.

^a P: power supply; I: input; O: output; T: high impedance. Pin functions in bold font are the default pin functions.
For pin 28 ~ 29, 31 ~ 33, the default function is decided by eFuse bit.

3 Get Started

3.1 What You Need

To develop applications for module you need:

- 1 x ESP32-S3-MINI-1 or ESP32-S3-MINI-1U
- 1 x Espressif RF testing board
- 1 x USB-to-Serial board
- 1 x Micro-USB cable
- 1 x PC running Linux

In this user guide, we take Linux operating system as an example. For more information about the configuration on Windows and macOS, please refer to [ESP-IDF Programming Guide](#).

3.2 Hardware Connection

1. Solder the ESP32-S3-MINI-1 or ESP32-S3-MINI-1U module to the RF testing board as shown in Figure 2.

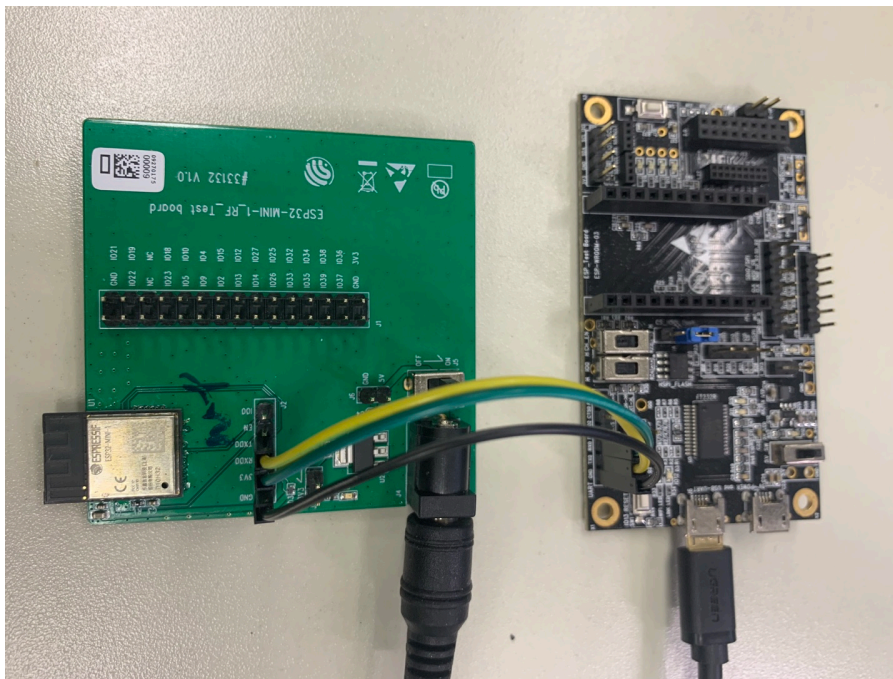


Figure 2: Hardware Connection

2. Connect the RF testing board to the USB-to-Serial board via TXD, RXD, and GND.
3. Connect the USB-to-Serial board to the PC.
4. Connect the RF testing board to the PC or a power adapter to enable 5 V power supply, via the Micro-USB cable.
5. During download, connect IO0 to GND via a jumper. Then, turn "ON" the testing board.
6. Download firmware into flash. For details, see the sections below.

7. After download, remove the jumper on IO0 and GND.
8. Power up the RF testing board again. The module will switch to working mode. The chip will read programs from flash upon initialization.

Note:

IO0 is internally logic high. If IO0 is set to pull-up, the Boot mode is selected. If this pin is pull-down or left floating, the Download mode is selected. For more information on ESP32-S3-MINI-1 or ESP32-S3-MINI-1U, please refer to [ESP32-S3 Series Datasheet](#).

3.3 Set up Development Environment

The Espressif IoT Development Framework (ESP-IDF for short) is a framework for developing applications based on the Espressif ESP32. Users can develop applications with ESP32-S3 in Windows/Linux/macOS based on ESP-IDF. Here we take Linux operating system as an example.

3.3.1 Install Prerequisites

To compile with ESP-IDF you need to get the following packages:

- CentOS 7 & 8:

```
1  sudo yum -y update && sudo yum install git wget flex bison gperf python3 python3-
    pip
2  python3-setuptools cmake ninja-build ccache dfu-util libusbx
```

- Ubuntu and Debian:

```
1  sudo apt-get install git wget flex bison gperf python3 python3-pip python3-
    setuptools
2  cmake ninja-build ccache libffi-dev libssl-dev dfu-util libusb-1.0-0
```

- Arch:

```
1  sudo pacman -S --needed gcc git make flex bison gperf python-pip cmake ninja
    ccache
2  dfu-util libusb
```

Note:

- This guide uses the directory ~/esp on Linux as an installation folder for ESP-IDF.
- Keep in mind that ESP-IDF does not support spaces in paths.

3.3.2 Get ESP-IDF

To build applications for ESP32-S3-MINI-1 or ESP32-S3-MINI-1U module, you need the software libraries provided by Espressif in [ESP-IDF repository](#).

To get ESP-IDF, create an installation directory (~/esp) to download ESP-IDF to and clone the repository with 'git clone':

```
1 mkdir -p ~/esp
2 cd ~/esp
3 git clone --recursive https://github.com/espressif/esp-idf.git
```

ESP-IDF will be downloaded into ~/esp/esp-idf. Consult [ESP-IDF Versions](#) for information about which ESP-IDF version to use in a given situation.

3.3.3 Set up Tools

Aside from the ESP-IDF, you also need to install the tools used by ESP-IDF, such as the compiler, debugger, Python packages, etc. ESP-IDF provides a script named 'install.sh' to help set up the tools in one go.

```
1 cd ~/esp/esp-idf
2 ./install.sh
```

3.3.4 Set up Environment Variables

The installed tools are not yet added to the PATH environment variable. To make the tools usable from the command line, some environment variables must be set. ESP-IDF provides another script 'export.sh' which does that. In the terminal where you are going to use ESP-IDF, run:

```
1 . $HOME/esp/esp-idf/export.sh
```

Now everything is ready, you can build your first project on ESP32-S3-MINI-1 or ESP32-S3-MINI-1U module.

3.4 Create Your First Project

3.4.1 Start a Project

Now you are ready to prepare your application for ESP32-S3-MINI-1 or ESP32-S3-MINI-1U module. You can start with [get-started/hello_world](#) project from [examples directory](#) in ESP-IDF.

Copy get-started/hello_world to ~/esp directory:

```
1 cd ~/esp
2 cp -r $IDF_PATH/examples/get-started/hello_world .
```

There is a range of [example projects](#) in the examples directory in ESP-IDF. You can copy any project in the same way as presented above and run it. It is also possible to build examples in-place, without copying them first.

3.4.2 Connect Your Device

Now connect your module to the computer and check under what serial port the module is visible. Serial ports in Linux start with '/dev/tty' in their names. Run the command below two times, first with the board unplugged, then with plugged in. The port which appears the second time is the one you need:

```
1 ls /dev/tty*
```

Note:

Keep the port name handy as you will need it in the next steps.

3.4.3 Configure

Navigate to your 'hello_world' directory from Step 3.4.1. Start a Project, set ESP32-S3 chip as the target and run the project configuration utility 'menuconfig'.

```
1 cd ~/esp/hello_world
2 idf.py set-target esp32s3
3 idf.py menuconfig
```

Setting the target with 'idf.py set-target ESP32-S3' should be done once, after opening a new project. If the project contains some existing builds and configuration, they will be cleared and initialized. The target may be saved in environment variable to skip this step at all. See [Selecting the Target](#) for additional information.

If the previous steps have been done correctly, the following menu appears:

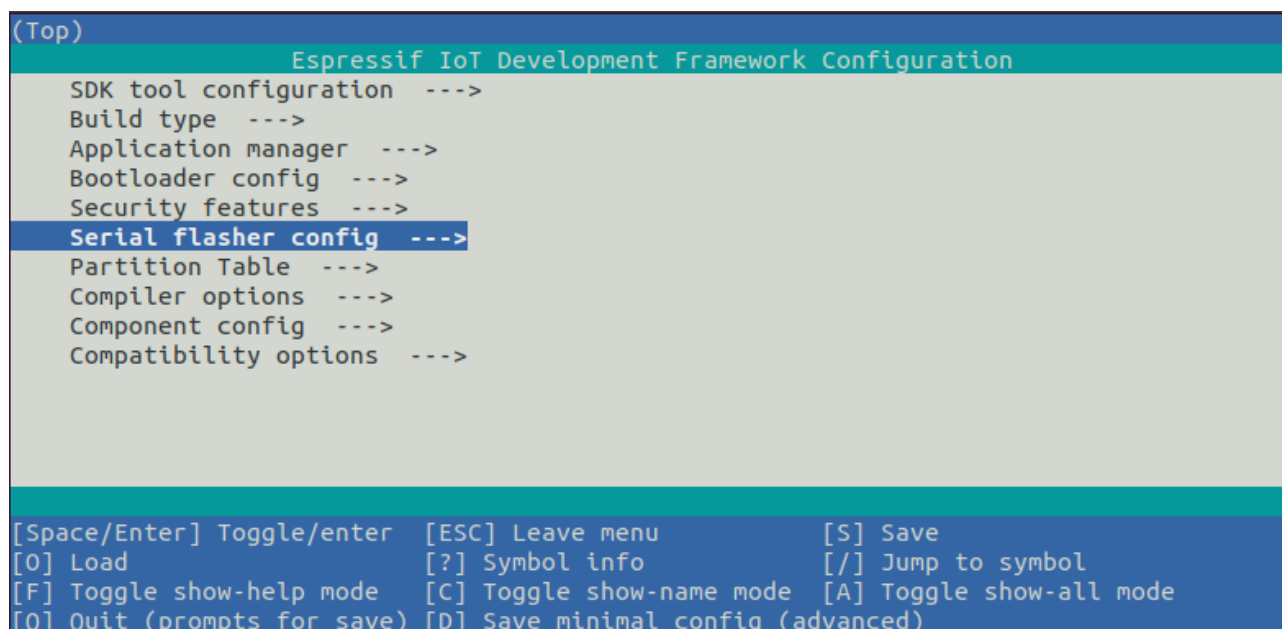


Figure 3: Project Configuration - Home Window

You are using this menu to set up project specific variables, e.g. Wi-Fi network name and password, the processor speed, etc. Setting up the project with menuconfig may be skipped for "hello_world". This example will run with default configuration

The colors of the menu could be different in your terminal. You can change the appearance with the option '--style'. Please run 'idf.py menuconfig --help' for further information.

3.4.4 Build the Project

Build the project by running:

```
1 idf.py build
```

This command will compile the application and all ESP-IDF components, then it will generate the bootloader, partition table, and application binaries.

```

1  $ idf.py build
2  Running cmake in directory /path/to/hello_world/build
3  Executing "cmake -G Ninja --warn-uninitialized /path/to/hello_world"...
4  Warn about uninitialized values.
5  -- Found Git: /usr/bin/git (found version "2.17.0")
6  -- Building empty aws_iot component due to configuration
7  -- Component names: ...
8  -- Component paths: ...
9
10 ... (more lines of build system output)
11
12 [527/527] Generating hello_world.bin
13 esptool.py v2.3.1
14
15 Project build complete. To flash, run this command:
16 ../../../../components/esptool_py/esptool/esptool.py -p (PORT) -b 921600
17 write_flash --flash_mode dio --flash_size detect --flash_freq 40m
18 0x10000 build/hello_world.bin build 0x1000 build/bootloader/bootloader.bin 0x8000
19 build/partition_table/partition-table.bin
20 or run 'idf.py -p PORT flash'

```

If there are no errors, the build will finish by generating the firmware binary .bin file.

3.4.5 Flash onto the Device

Flash the binaries that you just built onto your module by running:

```
1 idf.py -p PORT [-b BAUD] flash
```

Replace PORT with your ESP32-S3 board's serial port name from [Step: Connect Your Device](#).

You can also change the flasher baud rate by replacing BAUD with the baud rate you need. The default baud rate is 460800.

For more information on idf.py arguments, see [idf.py](#).

Note:

The option 'flash' automatically builds and flashes the project, so running 'idf.py build' is not necessary.

When flashing, you will see the output log similar to the following:

```

1  ...
2  esptool.py esp32s3 -p /dev/ttyUSB0 -b 460800 --before=default_reset --after=hard_reset
3  write_flash --flash_mode dio --flash_freq 80m --flash_size 2MB 0x0 bootloader/bootloader.
   bin
4  0x10000 hello_world.bin 0x8000 partition_table/partition-table.bin
5  esptool.py v3.2-dev
6  Serial port /dev/ttyUSB0
7  Connecting....

```

```

 8  Chip is ESP32-S3
 9  Features: WiFi, BLE
10  Crystal is 40MHz
11  MAC: 7c:df:a1:e0:00:64
12  Uploading stub...
13  Running stub...
14  Stub running...
15  Changing baud rate to 460800
16  Changed.
17  Configuring flash size...
18  Flash will be erased from 0x00000000 to 0x00004fff...
19  Flash will be erased from 0x00010000 to 0x00039fff...
20  Flash will be erased from 0x00008000 to 0x00008fff...
21  Compressed 18896 bytes to 11758...
22  Writing at 0x00000000... (100 %)
23  Wrote 18896 bytes (11758 compressed) at 0x00000000 in 0.5 seconds (effective 279.9 kbit/s)
    ...
24  Hash of data verified.
25  Compressed 168208 bytes to 88178...
26  Writing at 0x00010000... (16 %)
27  Writing at 0x0001a80f... (33 %)
28  Writing at 0x000201f1... (50 %)
29  Writing at 0x00025dcf... (66 %)
30  Writing at 0x0002d0be... (83 %)
31  Writing at 0x00036c07... (100 %)
32  Wrote 168208 bytes (88178 compressed) at 0x00010000 in 2.4 seconds (effective 569.2 kbit/s)
    ...
33  Hash of data verified.
34  Compressed 3072 bytes to 103...
35  Writing at 0x00008000... (100 %)
36  Wrote 3072 bytes (103 compressed) at 0x00008000 in 0.1 seconds (effective 478.9 kbit/s)...
37  Hash of data verified.
38
39  Leaving...
40  Hard resetting via RTS pin...
41  Done

```

If there are no issues by the end of the flash process, the board will reboot and start up the “hello_world” application.

3.4.6 Monitor

To check if “hello_world” is indeed running, type ‘idf.py -p PORT monitor’ (Do not forget to replace PORT with your serial port name).

This command launches the IDF Monitor application:

```

 1  $ idf.py -p /dev/ttyUSB0 monitor
 2  Running idf_monitor in directory [...]/esp/hello_world/build
 3  Executing "python [...]/esp-idf/tools/idf_monitor.py -b 115200
 4  [...]/esp/hello_world/build/hello-world.elf"...

```

```
5 --- idf_monitor on /dev/ttyUSB0 115200 ---
6 --- Quit: Ctrl+] | Menu: Ctrl+T | Help: Ctrl+T followed by Ctrl+H ---
7 ets Jun  8 2016 00:22:57
8
9 rst:0x1 (POWERON_RESET),boot:0x13 (SPI_FAST_FLASH_BOOT)
10 ets Jun  8 2016 00:22:57
11 ...
```

After startup and diagnostic logs scroll up, you should see “Hello world!” printed out by the application.

```
1 ...
2 Hello world!
3 Restarting in 10 seconds...
4 This is esp32s3 chip with 2 CPU core(s), This is esp32s3 chip with 2 CPU core(s), WiFi/BLE
5 ,
6 silicon revision 0, 2MB external flash
7 Minimum free heap size: 390684 bytes
8 Restarting in 9 seconds...
9 Restarting in 8 seconds...
10 Restarting in 7 seconds...
```

To exit IDF monitor use the shortcut Ctrl+].

That’s all what you need to get started with ESP32-S3-MINI-1 or ESP32-S3-MINI-1U module! Now you are ready to try some other [examples](#) in ESP-IDF, or go right to developing your own applications.

4 U.S. FCC Statement

The devices comply with KDB 996369 D03 OEM Manual v01. Below are integration instructions for host product manufacturers according to the KDB 996369 D03 OEM Manual v01.

List of Applicable FCC Rules

FCC Part 15 Subpart C 15.247 & 15.209

Specific Operational Use Conditions

The modules have WiFi, BR, EDR, and BLE functions.

- Operation Frequency:
 - WiFi: 2412 ~ 2462 MHz
 - Bluetooth: 2402 ~ 2480 MHz
- Number of Channel:
 - WiFi: 12
 - Bluetooth: 40
- Modulation:
 - WiFi: DSSS; OFDM
 - Bluetooth: GFSK; $\pi/4$ DQPSK; 8 DPSK
- Type: On-board PCB antenna or external antenna connector
- Gain: 4.54 dBi Max

The modules can be used for IoT applications with a maximum 3.96 dBi antenna. The host manufacturer installing the modules into their product must ensure that the final composite product complies with the FCC requirements by a technical assessment or evaluation to the FCC rules, including the transmitter operation. The host manufacturer has to be aware not to provide information to the end user regarding how to install or remove the RF modules in the user's manual of the end product which integrates the modules. The end user manual shall include all required regulatory information/warning as shown in this manual.

Limited Module Procedures

Not applicable. The modules are single modules and comply with the requirement of FCC Part 15.212.

Trace Antenna Designs

Not applicable. The modules have their own antenna, and do not need a host's printed board microstrip trace antenna, etc.

RF Exposure Considerations

The modules must be installed in the host equipment such that at least 20cm is maintained between the antenna and users' body; and if RF exposure statement or module layout is changed, then the host product manufacturer

required to take responsibility of the modules through a change in FCC ID or new application. The FCC ID of the modules cannot be used on the final product. In these circumstances, the host manufacturer will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate FCC authorization.

Antennas

Antenna specification are as follows:

- Type: On-board PCB antenna
- Gain: 3.96 dBi
- Type: External antenna connector
- Gain: 4.54 dBi

This device is intended only for host manufacturers under the following conditions:

- The transmitter module may not be co-located with any other transmitter or antenna.
- The modules shall be only used with the external antenna(s) that has been originally tested and certified with the modules.
- The antenna must be either permanently attached or employ a 'unique' antenna coupler.

As long as the conditions above are met, further transmitter test will not be required. However, the host manufacturer is still responsible for testing their end-product for any additional compliance requirements required with the modules installed (for example, digital device emissions, PC peripheral requirements, etc.).

Label and Compliance Information

Host product manufacturers need to provide a physical or e-label stating "Contains FCC ID: 2AC7Z-ESPS3MINI1" with their finished product.

Information on test modes and additional testing requirements

- Operation Frequency:
 - WiFi: 2412 ~ 2462 MHz
 - Bluetooth: 2402 ~ 2480 MHz
- Number of Channel:
 - WiFi: 12
 - Bluetooth: 40
- Modulation:
 - WiFi: DSSS; OFDM
 - Bluetooth: GFSK; $\pi/4$ DQPSK; 8 DPSK

Host manufacturer must perform test of radiated and conducted emission and spurious emission, etc., according to the actual test modes for a stand-alone modular transmitter in a host, as well as for multiple simultaneously transmitting modules or other transmitters in a host product. Only when all the test results of test modes comply with FCC requirements, then the end product can be sold legally.

Additional testing, Part 15 Subpart B compliant

The modular transmitter is only FCC authorized for FCC Part 15 Subpart C 15.247 & 15.209 and that the host product manufacturer is responsible for compliance to any other FCC rules that apply to the host not covered by the modular transmitter grant of certification. If the grantee markets their product as being Part 15 Subpart B compliant (when it also contains unintentional-radiator digital circuitry), then the grantee shall provide a notice stating that the final host product still requires Part 15 Subpart B compliance testing with the modular transmitter installed.

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications.

However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

The devices comply with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

- This device may not cause harmful interference.
- This device must accept any interference received, including interference that may cause undesired operation.

Caution:

Any changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

The equipment complies with FCC RF radiation exposure limits set forth for an uncontrolled environment. This device and its antenna must not be co-located or operating in conjunction with any other antenna or transmitter. The antennas used for this transmitter must be installed to provide a separation distance of at least 20 cm from all persons and must not be co-located or operating in conjunction with any other antenna or transmitter.

OEM Integration Instructions

The devices are intended only for OEM integrators under the following conditions:

- The transmitter module may not be co-located with any other transmitter or antenna.
- The modules shall be only used with the external antenna(s) that has been originally tested and certified with the modules.

As long as the conditions above are met, further transmitter test will not be required. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with the modules installed (for example, digital device emissions, PC peripheral requirements, etc.).

Validity of Using the Module Certification

In the event that these conditions cannot be met (for example certain laptop configurations or co-location with another transmitter), then the FCC authorization for the modules in combination with the host equipment is no longer considered valid and the FCC ID of the modules cannot be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate FCC authorization.

End Product Labeling

The final end product must be labeled in a visible area with the following: “Contains Transmitter Module FCC ID: 2AC7Z-ESPS3MINI1”.

5 Industry Canada Statement

This device complies with Industry Canada's licence-exempt RSSs. Operation is subject to the following two conditions:

- This device may not cause interference; and
- This device must accept any interference, including interference that may cause undesired operation of the device.

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes:

- l'appareil ne doit pas produire de brouillage, et
- l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Radiation Exposure Statement

This equipment complies with IC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20 cm between the radiator and your body.

Déclaration d'exposition aux radiations:

Cet équipement est conforme aux limites d'exposition aux rayonnements ISED établies pour un environnement non contrôlé. Cet équipement doit être installé et utilisé avec un minimum de 20 cm de distance entre la source de rayonnement et votre corps.

RSS-247 Section 6.4 (5)

The device could automatically discontinue transmission in case of absence of information to transmit, or operational failure. Note that this is not intended to prohibit transmission of control or signaling information or the use of repetitive codes where required by the technology.

L'appareil peut interrompre automatiquement la transmission en cas d'absence d'informations à transmettre ou de panne opérationnelle. Notez que ceci n'est pas destiné à interdire la transmission d'informations de contrôle ou de signalisation ou l'utilisation de codes répétitifs lorsque cela est requis par la technologie.

This device is intended only for OEM integrators under the following conditions (For module device use):

- The antenna must be installed such that 20 cm is maintained between the antenna and users, and
- The transmitter module may not be co-located with any other transmitter or antenna.

As long as 2 conditions above are met, further transmitter test will not be required. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this module installed.

Cet appareil est conçu uniquement pour les intégrateurs OEM dans les conditions suivantes (Pour utilisation de dispositif module):

- L'antenne doit être installée de telle sorte qu'une distance de 20 cm est respectée entre l'antenne et les utilisateurs, et
- Le module émetteur peut ne pas être coïmplanté avec un autre émetteur ou antenne.

Tant que les 2 conditions ci-dessus sont remplies, des essais supplémentaires sur l'émetteur ne seront pas nécessaires. Toutefois, l'intégrateur OEM est toujours responsable des essais sur son produit final pour toutes exigences de conformité supplémentaires requis pour ce module installé.

IMPORTANT NOTE:

In the event that these conditions can not be met (for example certain laptop configurations or colocation with another transmitter), then the Canada authorization is no longer considered valid and the IC ID can not be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate Canada authorization.

NOTE IMPORTANTE:

Dans le cas où ces conditions ne peuvent être satisfaites (par exemple pour certaines configurations d'ordinateur portable ou de certaines co-localisation avec un autre émetteur), l'autorisation du Canada n'est plus considéré comme valide et l'ID IC ne peut pas être utilisé sur le produit final. Dans ces circonstances, l'intégrateur OEM sera chargé de réévaluer le produit final (y compris l'émetteur) et l'obtention d'une autorisation distincte au Canada.

End Product Labeling

This transmitter module is authorized only for use in device where the antenna may be installed such that 20 cm may be maintained between the antenna and users. The final end product must be labeled in a visible area with the following: "Contains IC: 21098-ESPS3MINI1".

Plaque signalétique du produit final

Ce module émetteur est autorisé uniquement pour une utilisation dans un dispositif où l'antenne peut être installée de telle sorte qu'une distance de 20cm peut être maintenue entre l'antenne et les utilisateurs. Le produit final doit être étiqueté dans un endroit visible avec l'inscription suivante: "Contient des IC: 21098-ESPS3MINI1".

Manual Information to the End User

The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove this RF module in the user's manual of the end product which integrates this module. The end user manual shall include all required regulatory information/warning as show in this manual.

Manuel d'information à l'utilisateur final

L'intégrateur OEM doit être conscient de ne pas fournir des informations à l'utilisateur final quant à la façon d'installer ou de supprimer ce module RF dans le manuel de l'utilisateur du produit final qui intègre ce module. Le

manuel de l'utilisateur final doit inclure toutes les informations réglementaires requises et avertissements comme indiqué dans ce manuel.

6 Related Documentation and Resources

Related Documentation

- [ESP32-S3 Technical Reference Manual](#) – Detailed information on how to use the ESP32-S3 memory and peripherals.
- [ESP32-S3 Series Datasheet](#) – Specifications of the ESP32-S3 hardware.
- [ESP32-S3 Hardware Design Guidelines](#) – Guidelines on how to integrate the ESP32-S3 into your hardware product.
- *Certificates*
<http://espressif.com/en/support/documents/certificates>
- *Documentation Updates and Update Notification Subscription*
<http://espressif.com/en/support/download/documents>

Developer Zone

- [ESP-IDF Programming Guide for ESP32-S3](#) – Extensive documentation for the ESP-IDF development framework.
- *ESP-IDF* and other development frameworks on GitHub.
<http://github.com/espressif>
- *ESP32 BBS Forum* – Engineer-to-Engineer (E2E) Community for Espressif products where you can post questions, share knowledge, explore ideas, and help solve problems with fellow engineers.
<http://esp32.com/>
- *The ESP Journal* – Best Practices, Articles, and Notes from Espressif folks.
<http://medium.com/the-esp-journal>
- See the tabs *SDKs and Demos*, *Apps*, *Tools*, *AT Firmware*.
<http://espressif.com/en/support/download/sdks-demos>

Products

- *ESP32-S3 Series SoCs* – Browse through all ESP32-S3 SoCs.
<http://espressif.com/en/products/socs?id=ESP32-S3>
- *ESP32-S3 Series Modules* – Browse through all ESP32-S3-based modules.
<http://espressif.com/en/products/modules?id=ESP32-S3>
- *ESP32-S3 Series DevKits* – Browse through all ESP32-S3-based devkits.
<http://espressif.com/en/products/devkits?id=ESP32-S3>
- *ESP Product Selector* – Find an Espressif hardware product suitable for your needs by comparing or applying filters.
<http://products.espressif.com/#/product-selector?language=en>

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<http://espressif.com/en/contact-us/sales-questions>

Revision History

Date	Version	Release notes
2022-02-24	v0.6	Overall update for chip revision 1
2021-03-30	v0.1	Preliminary release, for chip revision 0



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